2500V

2200A

180A



## **Rectifier Diode**

Replaces March 1998 version, DS4084-2.3

DS4084-3.0 January 2000

**KEY PARAMETERS** 

 $V_{RRM}$ 

I<sub>F(AV)</sub>

### APPLICATIONS

■ Rectification

■ Freewheel Diode

■ DC Motor Control

■ Power Supplies

■ Welding

■ Battery Chargers

### **FEATURES**

■ High Surge Capability

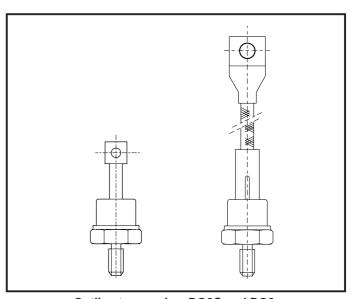
### **VOLTAGE RATINGS**

Type Number	Repetitive Peak Reverse Voltage V	Conditions
SV10 25 M or K(R) SV10 20 M or K(R) SV10 16 M or K(R)	2000	$V_{RSM} = V_{RRM} + 100V$

Lower voltage grades available.

M for M12 thread. K for 1/2" - 20UNF thread, R for reverse polarity.

Add C to type number for DO8C package.



Outline type codes: DO8C and DO8. See Package Details for further information.

### **CURRENT RATINGS**

Symbol	Parameter	Conditions	Max.	Units
Single Side Cooled				
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, T <sub>case</sub> = 100°C	180	А
I <sub>F(RMS)</sub>	RMS value	T <sub>case</sub> = 100°C	283	А
I <sub>F</sub>	Continuous (direct) forward current	T <sub>case</sub> = 100°C	233	А

# SV10

# **SURGE RATINGS**

Symbol	Parameter	Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10ms half sine; T <sub>case</sub> = 175°C	1.76	kA
l²t	I <sup>2</sup> t for fusing	V <sub>R</sub> = 50% V <sub>RRM</sub> - 1/4 sine	14.9 x 10 <sup>3</sup>	A <sup>2</sup> s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10ms half sine; T <sub>case</sub> =175°C	2.2	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_R = 0$	24.0 x 10 <sup>3</sup>	A <sup>2</sup> s

## THERMAL AND MECHANICAL DATA

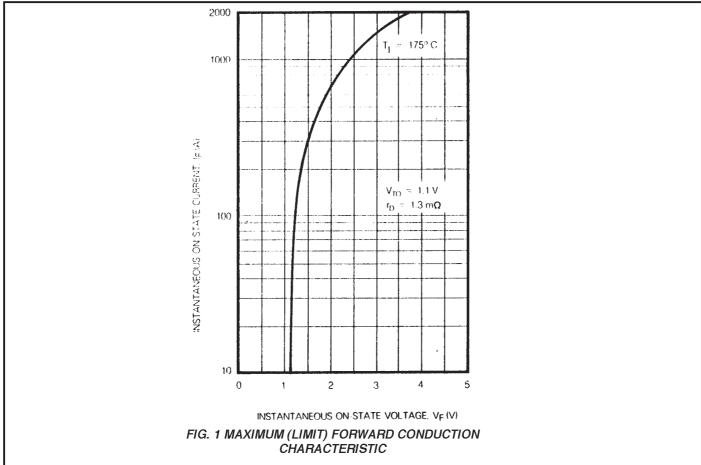
Symbol	Parameter	Conditions	Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance - junction to case	dc	-	0.23	°C/W
R <sub>th(c-h)</sub>	Thermal resistance - case to heatsink  Mounting torque 15.0Nm with mounting compound		-	0.08	°C/W
T <sub>vj</sub>	Virtual junction temperature	On-state (conducting)	-	175	°C
		Reverse (blocking)	-	175	°C
T <sub>stg</sub>	Storage temperature range		-55	200	°C
-	Mounting Torque		12.0	15.0	Nm

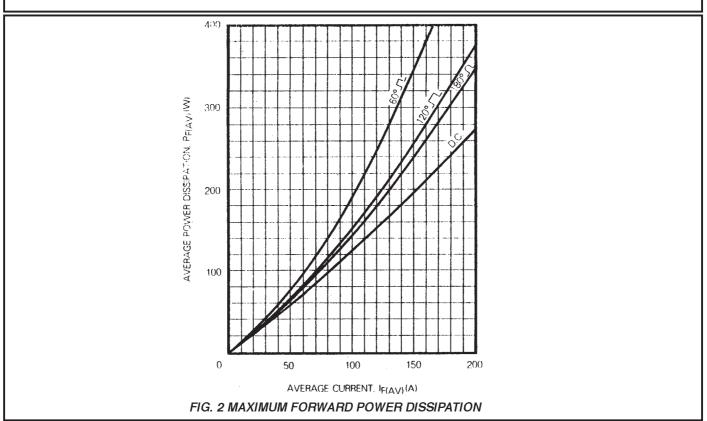
# **CHARACTERISTICS**

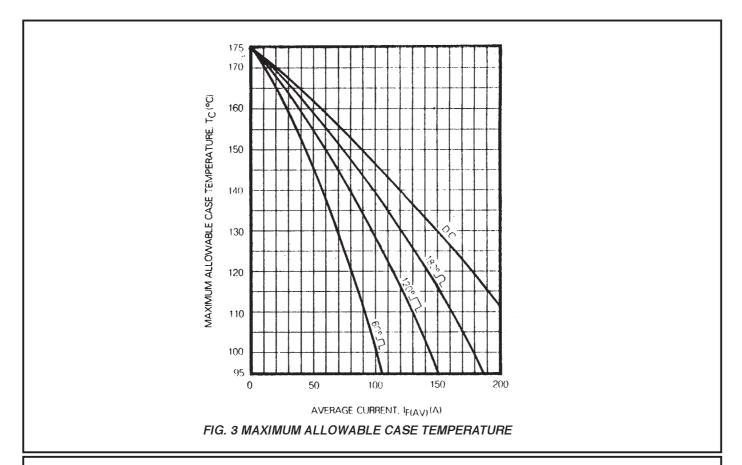
Symbol	Parameter	Conditions	Тур.	Max.	Units
$V_{\scriptscriptstyle{\sf FM}}$	Forward voltage	At 300A peak, T <sub>case</sub> = 25°C	-	1.5	V
I <sub>RRM</sub>	Peak reverse current	At V <sub>RRM</sub> , T <sub>case</sub> = 175°C	-	20	mA
$Q_s$	Total stored charge		300*	-	μС
I <sub>RM</sub>	Peak recovery current	$I_F = 100A$ , $dI_{RR}/dt = 20A/\mu s$ , $T_{case} = 25^{\circ}C$	100*	-	А
t <sub>rr</sub>	reverse recovery time			-	μѕ
V <sub>TO</sub>	Threshold voltage	At T <sub>vj</sub> = 175°C	-	1.1	V
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 175°C	-	1.3	mΩ

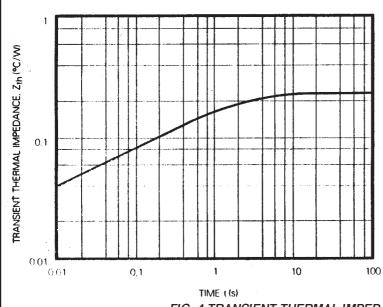
<sup>\*</sup>Typical values.

### **CURVES**



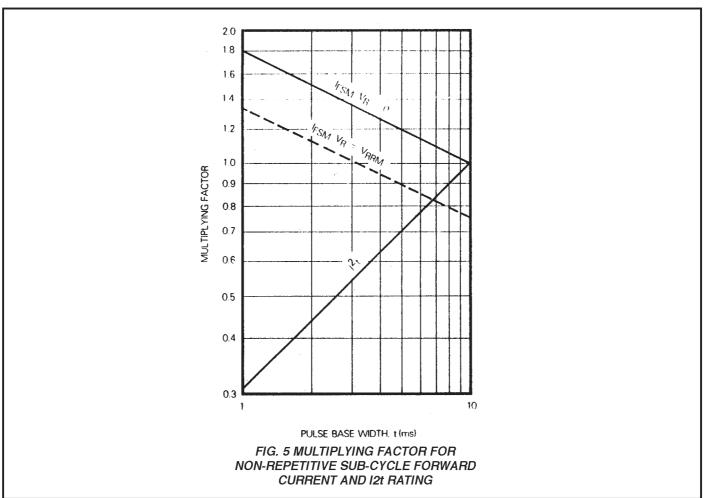


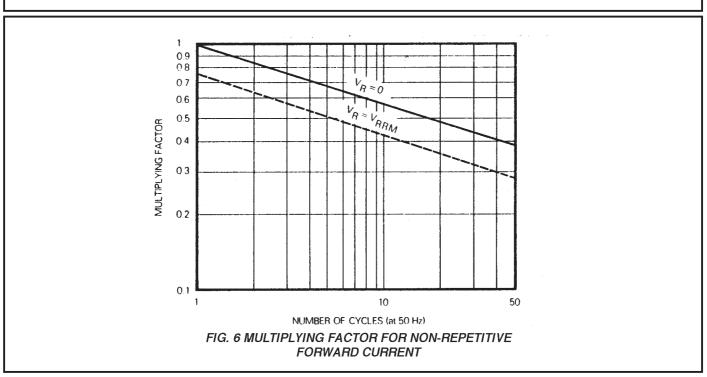




Conduction	Effective thermal Resistance (°C/W)  Junction to case	
angle	Sinusoidat	Rectangular
180°	0.248	0.276
120°	0.258	0.311
60°	0.299	0.301

FIG. 4 TRANSIENT THERMAL IMPEDANCE - JUNCTION TO CASE

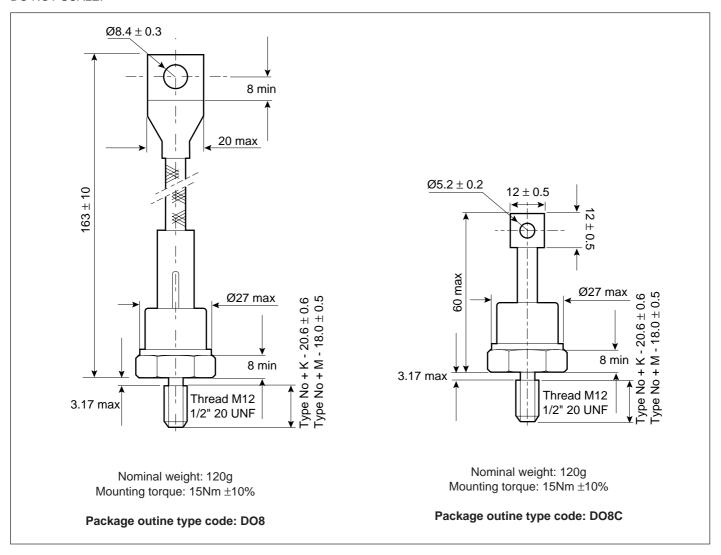




#### **SV10**

### **PACKAGE DETAILS**

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



## **ASSOCIATED PUBLICATIONS**

Title	Application Note	
	Number	
Calculating the junction temperature or power semiconductors	AN4506	
Thyristor and diode measurement with a multi-meter	AN4853	
Use of $V_{TO}$ , $r_{T}$ on-state characteristic	AN5001	

#### POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink / clamping systems in line with advances in device types and the voltage and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the up to date CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete solution (PACs).

#### **DEVICE CLAMPS**

Disc devices require the correct clamping force to ensure their safe operation. The PACs range offers a varied selection of preloaded clamps to suit all of our manufactured devices. This include cube clamps for single side cooling of 'T' 22mm

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

#### **HEATSINKS**

Power Assembly has it's own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance or our semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest Sales Representative or the factory.



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Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

Advance Information: The product design is complete and final characterisation for volume production is well in hand.

No Annotation: The product parameters are fixed and the product is available to datasheet specification.

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